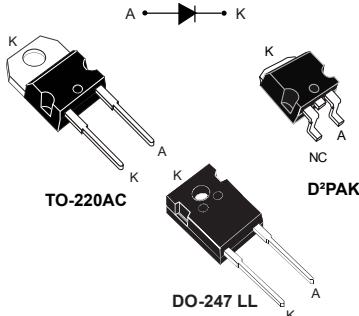


1200 V, 20 A power Schottky silicon carbide diode



Features

- None or negligible reverse recovery
- Switching behavior independent of temperature
- Robust high voltage periphery
- Operating T_j from -40 °C to 175 °C
- ECOPACK2 compliant component

Applications

- Solar inverter
- Boost PFC
- Air conditioning equipment
- UPS power supply
- Telecom / Server power equipment
- HEV/EV OBC (On board battery chargers)
- EV Charging station

Description

The SiC diode, available in TO-220AC, D²PAK and TO-247 LL, is an ultrahigh performance power Schottky rectifier. It is manufactured using a silicon carbide substrate. The wide band-gap material allows the design of a low V_F Schottky diode structure with a 1200 V rating. Due to the Schottky construction, no recovery is shown at turn-off and ringing patterns are negligible. The minimal capacitive turn-off behavior is independent of temperature.

Especially suited for use in PFC and secondary side applications, this ST SiC diode boost the performance in hard switching conditions. This rectifier enhance the performance of the targeted application. Its high forward surge capability ensures a good robustness during transient phases.

Product label



Product status link

[STPSC20H12C](#)

Product summary

| | |
|--------------|--------|
| $I_{F(AV)}$ | 20 A |
| V_{RRM} | 1200 V |
| T_j (max.) | 175 °C |
| V_F (typ.) | 1.35 V |

1 Characteristics

Table 1. Absolute ratings (limiting values at 25 °C, unless otherwise specified)

| Symbol | Parameter | | Value | Unit |
|---------------------|--|--|----------------|------|
| V _{RRM} | Repetitive peak reverse voltage ($T_j = -40$ °C to +175 °C) | | 1200 | V |
| I _{F(RMS)} | Forward rms current | | 38 | A |
| I _{F(AV)} | Average forward current | TO-220AC, D ² PAK, $T_C = 155$ °C, DC current ⁽¹⁾ | 20 | A |
| | | DO-247 LL, $T_C = 150$ °C, DC current ⁽¹⁾ | | |
| I _{FRM} | Repetitive peak forward current | TO-220AC, D ² PAK, $T_C = 155$ °C, $T_j = 175$ °C, $\delta = 0.1$ | 78 | A |
| | | DO-247 LL, $T_C = 150$ °C, $T_j = 175$ °C, $\delta = 0.1$ | 79 | |
| I _{FSM} | Surge non repetitive forward current | $t_p = 10$ ms sinusoidal | $T_C = 25$ °C | A |
| | | | $T_C = 150$ °C | |
| | | $t_p = 10$ µs square | $T_C = 25$ °C | |
| T _{stg} | Storage temperature range | | -65 to +175 | °C |
| T _j | Operating junction temperature range | | -40 to +175 | °C |

1. Value based on $R_{th(j-c)}$ max.

Table 2. Thermal parameters

| Symbol | Parameter | Typ. value | Max. value | Unit |
|----------------------|------------------|------------------------------|------------|------|
| R _{th(j-c)} | Junction to case | TO-220AC, D ² PAK | 0.30 | 0.45 |
| | | DO-247 LL | 0.40 | 0.55 |

For more information, you can refer to the following application note:

- [AN5088](#): Rectifiers thermal management, handling and mounting recommendations

Table 3. Static electrical characteristics

| Symbol | Parameter | Test conditions | | Min. | Typ. | Max. | Unit |
|-------------------------------|-------------------------|-------------------------|-----------------------------------|------|------|------|------|
| I _R ⁽¹⁾ | Reverse leakage current | T _j = 25 °C | V _R = V _{RRM} | - | 10 | 120 | µA |
| | | T _j = 150 °C | | - | 60 | 800 | |
| V _F ⁽²⁾ | Forward voltage drop | T _j = 25 °C | I _F = 20 A | - | 1.35 | 1.50 | V |
| | | T _j = 150 °C | | - | 1.75 | 2.25 | |

1. Pulse test: $t_p = 10$ ms, $\delta < 2\%$

2. Pulse test: $t_p = 500$ µs, $\delta < 2\%$

To evaluate the conduction losses use the following equation:

$$P = 1.07 \times I_{F(AV)} + 0.059 \times I_F^2 \text{ (RMS)}$$

For more information, you can refer to the following application notes related to the power losses:

- [AN604](#): Calculation of conduction losses in a power rectifier
- [AN4021](#): Calculation of reverse losses on a power diode

Table 4. Dynamic electrical characteristics

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|--------------------------------|-------------------------|---|------|------|------|------|
| Q_{Cj} <small>(1)</small> | Total capacitive charge | $V_R = 800 \text{ V}$ | - | 129 | - | nC |
| C_j | Total capacitance | $V_R = 0 \text{ V}, T_c = 25 \text{ }^\circ\text{C}, F = 1 \text{ MHz}$ | - | 1650 | - | pF |
| | | $V_R = 800 \text{ V}, T_c = 25 \text{ }^\circ\text{C}, F = 1 \text{ MHz}$ | - | 110 | - | |

1. Most accurate value for the capacitive charge:

$$Q_{cj}(V_R) = \int_0^{V_R} C_j(V) dV$$

1.1 Characteristics (curves)

Figure 1. Forward voltage drop versus forward current (typical values)

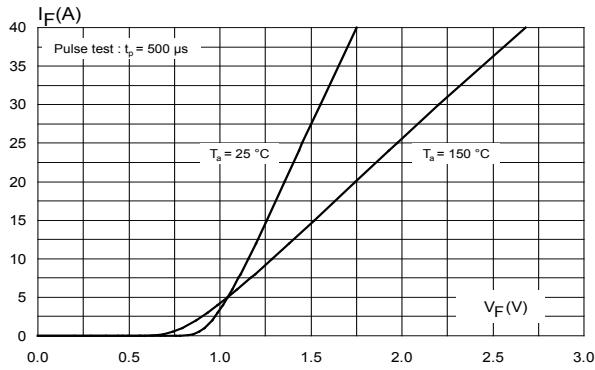


Figure 2. Reverse leakage current versus reverse voltage applied (typical values)

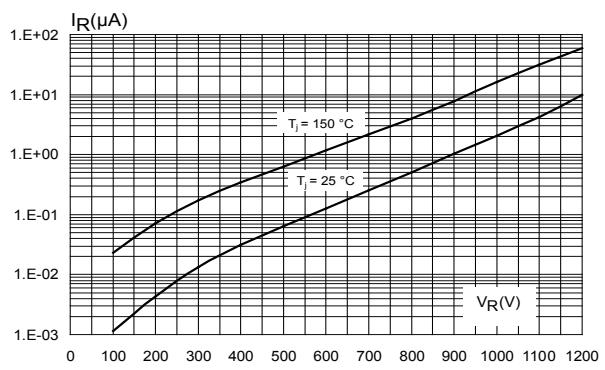


Figure 3. Peak forward current versus case temperature (TO-220AC, D²PAK)

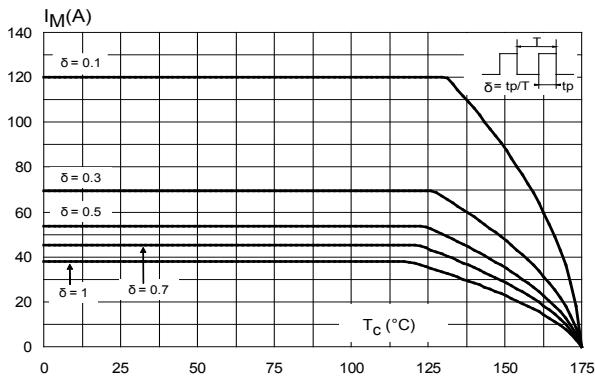


Figure 4. Peak forward current versus case temperature (DO-247 LL)

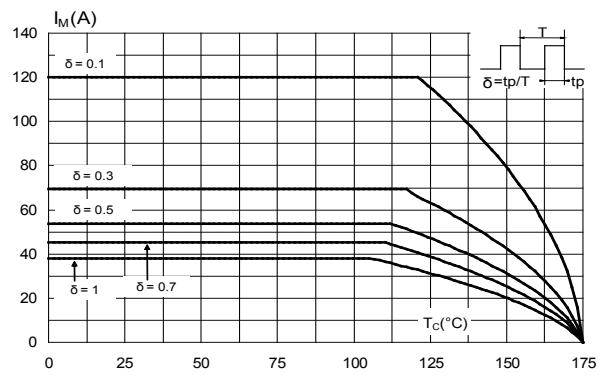


Figure 5. Junction capacitance versus reverse voltage applied (typical values)

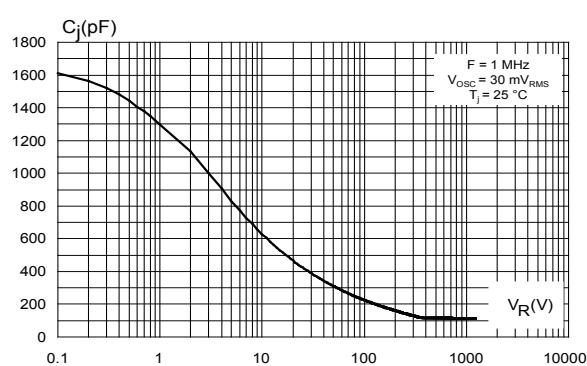


Figure 6. Relative variation of thermal impedance junction to case versus pulse duration (TO-220AC, D²PAK)

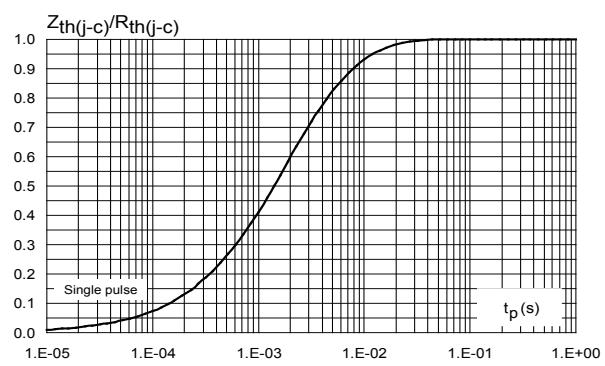


Figure 7. Relative variation of thermal impedance junction to case versus pulse duration (DO-247 LL)

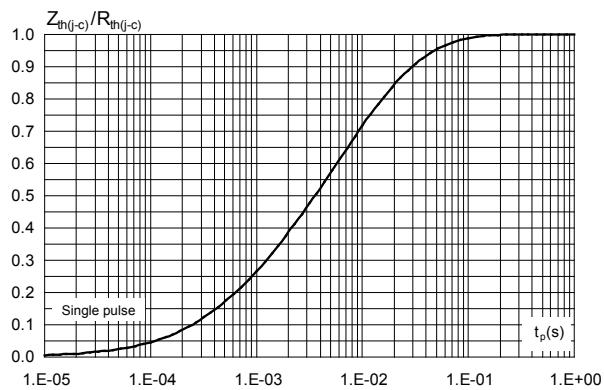


Figure 8. Non-repetitive peak surge forward current versus pulse duration (sinusoidal waveform)

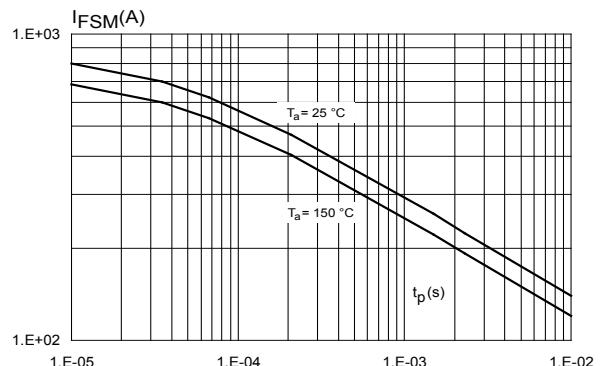


Figure 9. Total capacitive charges versus reverse voltage applied (typical values)

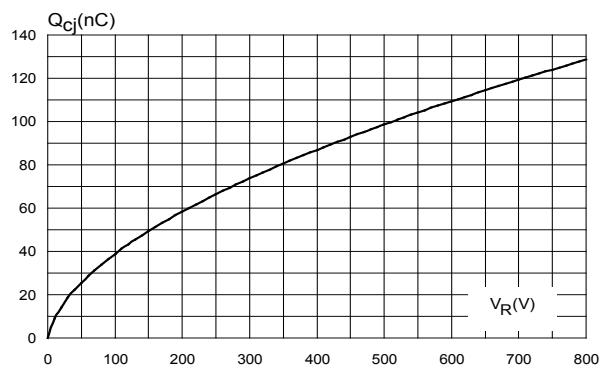
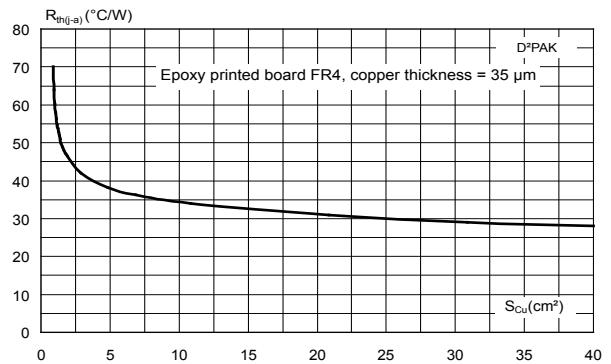


Figure 10. Thermal resistance junction to ambient versus copper surface under tab for D²PAK package (typical values)



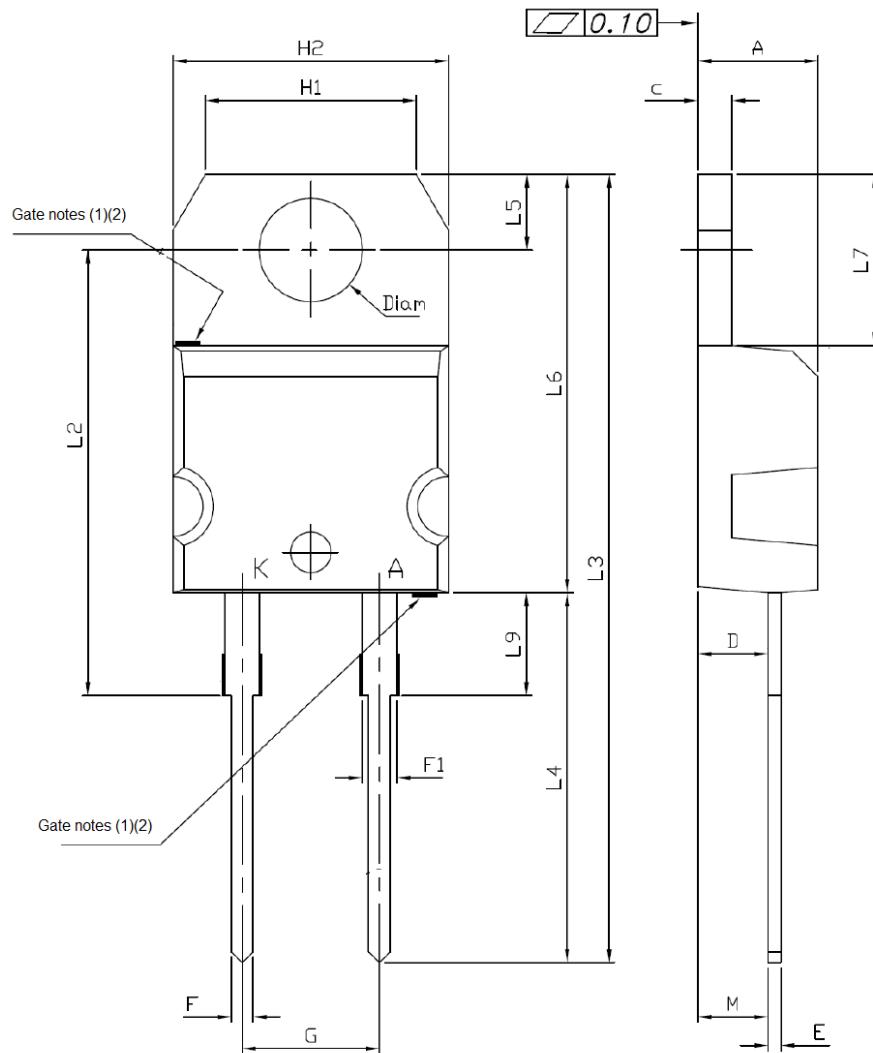
2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

2.1 TO-220AC package information

- Epoxy meets UL 94,V0
- Cooling method: by conduction (C)
- Recommended torque value: 0.55 N·m
- Maximum torque value: 0.70 N·m

Figure 11. TO-220AC package outline



(1) : Max resin gate protusion 0.5 mm

(2) : Resin gate position is accepted in each of the two positions
shown on the drawings or their symmetrical

Note:

This package drawing may slightly differ from the physical package. However, all the specified dimensions are guaranteed.

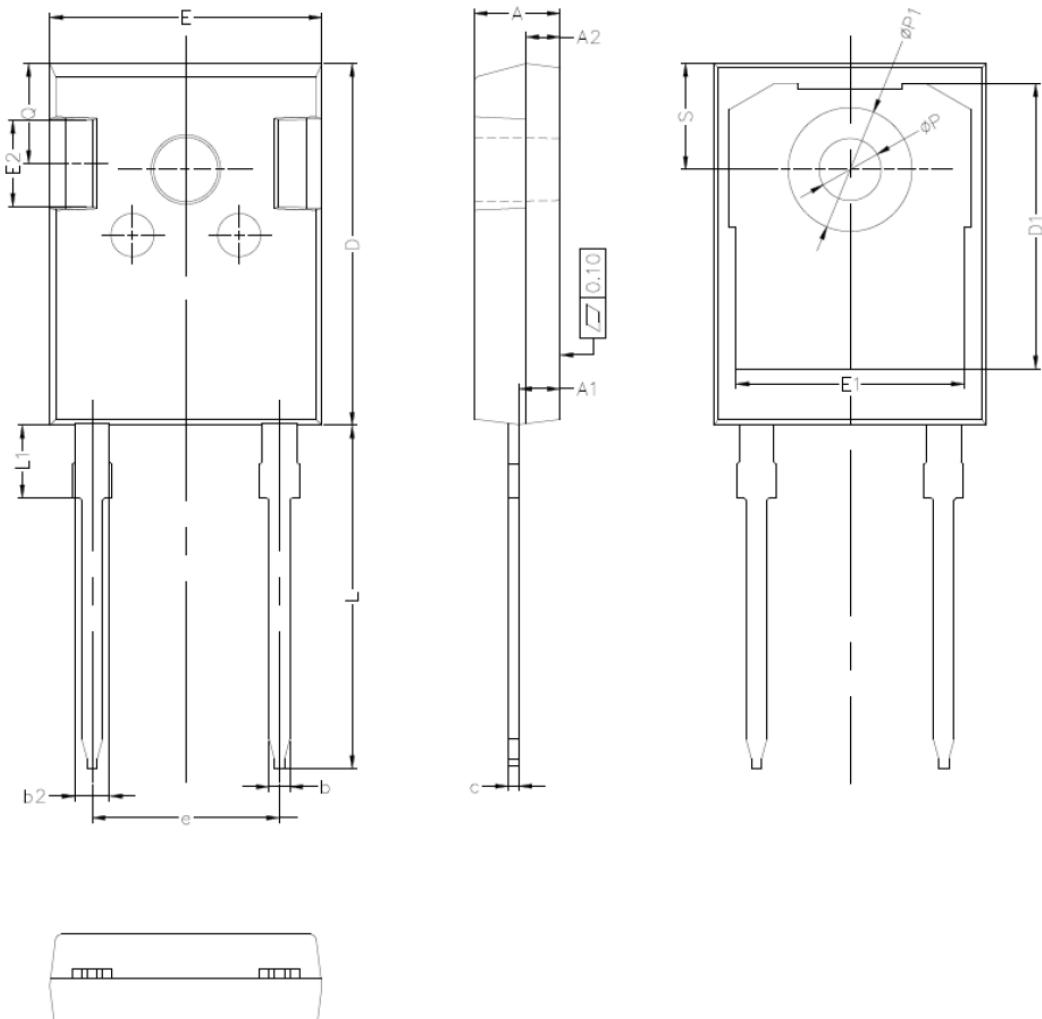
Table 5. TO-220AC package mechanical data

| Ref. | Dimensions | | | | | |
|---------------|-------------|-------|-------|-----------------------------|-------|-------|
| | Millimeters | | | Inches (for reference only) | | |
| | Min. | Typ. | Max. | Min. | Typ. | Max. |
| A | 4.40 | | 4.60 | 0.173 | | 0.181 |
| C | 1.23 | | 1.32 | 0.048 | | 0.051 |
| D | 2.40 | | 2.72 | 0.094 | | 0.107 |
| E | 0.49 | | 0.70 | 0.019 | | 0.027 |
| F | 0.61 | | 0.88 | 0.024 | | 0.034 |
| F1 | 1.14 | | 1.70 | 0.044 | | 0.066 |
| G | 4.95 | | 5.15 | 0.194 | | 0.202 |
| H2 | 10.00 | | 10.40 | 0.393 | | 0.409 |
| L2 | | 16.40 | | | 0.645 | |
| L4 | 13.00 | | 14.00 | 0.511 | | 0.551 |
| L5 | 2.65 | | 2.95 | 0.104 | | 0.116 |
| L6 | 15.25 | | 15.75 | 0.600 | | 0.620 |
| L7 | 6.20 | | 6.60 | 0.244 | | 0.259 |
| L9 | 3.50 | | 3.93 | 0.137 | | 0.154 |
| M | | 2.60 | | | 0.102 | |
| Diam | 3.75 | | 3.85 | 0.147 | | 0.151 |
| Slug flatness | | 0.03 | 0.10 | | 0.001 | 0.004 |

2.2 DO-247 LL package information

- Epoxy meets UL94, V0
- Cooling method: by conduction (C)
- Recommended torque value: 0.8 N·m
- Maximum torque value: 1.0 N·m

Figure 12. DO-247 LL package outline



Note: This package drawing may slightly differ from the physical package. However, all the specified dimensions are guaranteed.

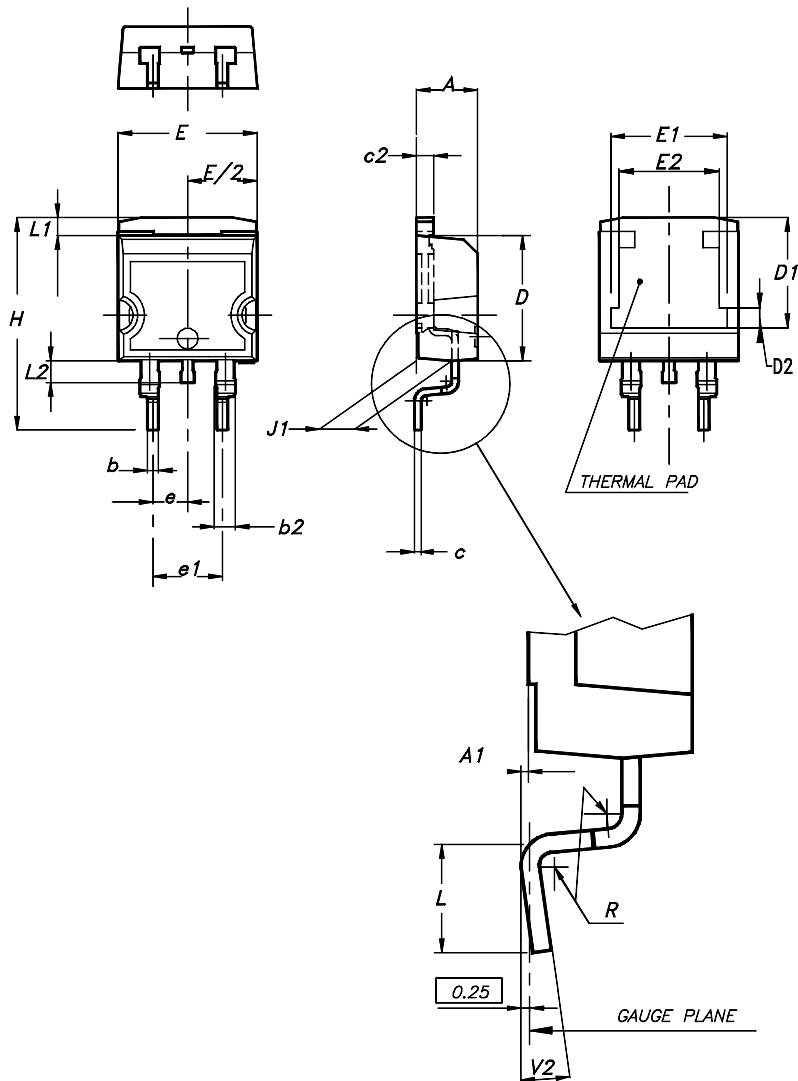
Table 6. DO-247 LL package mechanical data

| Ref. | Dimensions | | | |
|------|-------------|-------|-----------------------------|-------|
| | Millimeters | | Inches (for reference only) | |
| | Min. | Max. | Min. | Max. |
| A | 4.70 | 5.31 | 0.185 | 0.209 |
| A1 | 2.21 | 2.59 | 0.087 | 0.102 |
| A2 | 1.50 | 2.49 | 0.059 | 0.098 |
| b | 0.99 | 1.40 | 0.039 | 0.055 |
| b2 | 1.65 | 2.39 | 0.065 | 0.094 |
| c | 0.38 | 0.89 | 0.015 | 0.035 |
| D | 20.80 | 21.46 | 0.819 | 0.845 |
| D1 | 13.08 | | 0.515 | |
| E | 15.49 | 16.26 | 0.610 | 0.640 |
| e | 10.88 typ. | | 0.428 | |
| E1 | 13.06 | | 0.514 | |
| E2 | 3.43 | 5.10 | 0.135 | 0.200 |
| L | 19.80 | 20.32 | 0.779 | 0.800 |
| L1 | | 4.50 | | 0.177 |
| P | 3.50 | 3.70 | 0.137 | 0.146 |
| P1 | 7.00 | 7.40 | 0.275 | 0.292 |
| Q | 5.38 | 6.20 | 0.219 | 0.244 |
| S | 6.16 typ. | | 0.243 | |

2.3 D²PAK package information

- Epoxy meets UL94, V0
- Cooling method: by conduction (C)

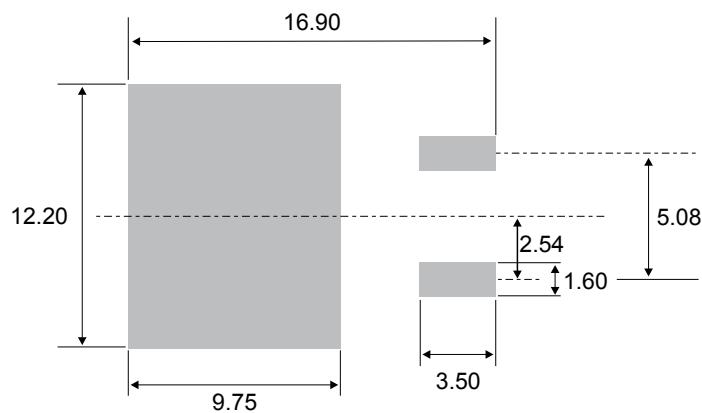
Figure 13. D²PAK package outline



Note: This package drawing may slightly differ from the physical package. However, all the specified dimensions are guaranteed.

Table 7. D²PAK package mechanical data

| Ref. | Dimensions | | | |
|------|-------------|-------|-----------------------------|-------|
| | Millimeters | | Inches (for reference only) | |
| | Min. | Max. | Min. | Max. |
| A | 4.36 | 4.60 | 0.172 | 0.181 |
| A1 | 0.00 | 0.25 | 0.000 | 0.010 |
| b | 0.70 | 0.93 | 0.028 | 0.037 |
| b2 | 1.14 | 1.70 | 0.045 | 0.067 |
| c | 0.38 | 0.69 | 0.015 | 0.027 |
| c2 | 1.19 | 1.36 | 0.047 | 0.053 |
| D | 8.60 | 9.35 | 0.339 | 0.368 |
| D1 | 6.90 | 8.00 | 0.272 | 0.311 |
| D2 | 1.10 | 1.50 | 0.043 | 0.060 |
| E | 10.00 | 10.55 | 0.394 | 0.415 |
| E1 | 8.10 | 8.90 | 0.319 | 0.346 |
| E2 | 6.85 | 7.25 | 0.266 | 0.282 |
| e | 2.54 typ. | | 0.100 | |
| e1 | 4.88 | 5.28 | 0.190 | 0.205 |
| H | 15.00 | 15.85 | 0.591 | 0.624 |
| J1 | 2.49 | 2.90 | 0.097 | 0.112 |
| L | 1.90 | 2.79 | 0.075 | 0.110 |
| L1 | 1.27 | 1.65 | 0.049 | 0.065 |
| L2 | 1.30 | 1.78 | 0.050 | 0.070 |
| R | 0.4 typ. | | 0.015 | |
| V2 | 0° | 8° | 0° | 8° |

Figure 14. D²PAK recommended footprint (dimensions in mm)

3 Ordering information

Table 8. Ordering information

| Order code | Marking | Package | Weight | Base qty. | Delivery mode |
|----------------|--------------|--------------------|--------|-----------|---------------|
| STPSC20H12D | STPSC20H12D | TO-220AC | 1.86 g | 50 | Tube |
| STPSC20H12WL | STPSC20H12WL | DO-247 LL | 5.9 g | 30 | Tube |
| STPSC20H12G-TR | STPSC20H12G | D ² PAK | 1.48 g | 1000 | Tape and reel |

Revision history

Table 9. Document revision history

| Date | Revision | Changes |
|-------------|----------|--|
| 13-May-2016 | 1 | Initial release. |
| 26-May-2016 | 2 | Updated <i>Table 2: "Absolute ratings (limiting values at 25 °C, unless otherwise specified)"</i> and <i>Figure 8: "Non-repetitive peak surge forward current versus pulse duration (sinusoidal waveform)"</i> . |
| 16-Mar-2017 | 3 | Added D²PAK package. |
| 05-Sep-2017 | 4 | Added DO-247 LL package. Updated Section "Features" , Section 1:"Characteristics" and Table 9: "Ordering information". |
| 10-Apr-2018 | 5 | Updated Section 2.2 DO-247 LL package information. |
| 15-Jul-2024 | 6 | Updated Table 6 . |

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